

**+3.3V, 2.5Gbps/2.7Gbps, SDH/SONET 4:1
Serializer with Clock Synthesis****MAX3892****General Description**

The MAX3892 serializer is ideal for converting 4-bit-wide, 622Mbps parallel data to 2.5Gbps serial data in DWDM and SONET/SDH applications. A 4 × 4-bit FIFO allows for any static delay between the parallel output clock and parallel input clock. Delay variation up to a unit interval (UI) is allowed after reset. A fully integrated phase-locked loop (PLL) synthesizes an internal 2.5GHz serial clock from a 622MHz, 155.5MHz, 77.8MHz, or 38.9MHz reference clock. A selectable dual VCO allows excellent jitter performance at both SONET and forward-error correction (FEC) data rates.

Operating from a single 3.3V supply, this device accepts low-voltage differential-signal (LVDS) clock and data inputs for interfacing with high-speed digital circuitry, and delivers current-mode logic (CML) serial data and clock outputs. A loopback data output is provided to facilitate system diagnostic testing. The MAX3892 is available in the extended temperature range (-40°C to +85°C) in 44-pin QFN and TQFN packages.

Applications

SONET/SDH OC-48 Transmission Systems
WDM Transponders
Add/Drop Multiplexers
Dense Digital Cross-Connects
Backplane Interconnects

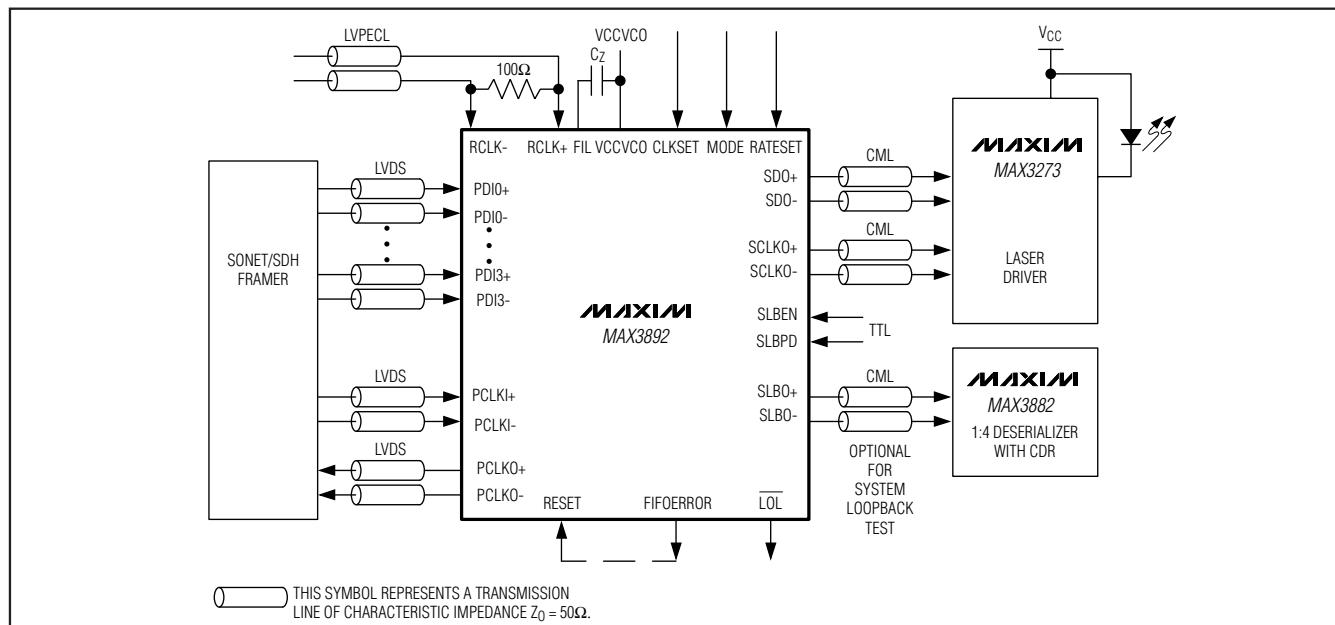
Features

- ◆ Single +3.3V Supply
- ◆ 455mW Power Consumption
- ◆ 1.4psRMS Maximum Jitter Generation
- ◆ 4 × 4-Bit FIFO Input Buffer
- ◆ 622Mbps/666Mbps Parallel to 2.5Gbps/2.7Gbps Serial Conversion
- ◆ 622MHz/667MHz or 311MHz/333MHz Clock Input
- ◆ On-Chip Clock Synthesizer
- ◆ Multiple Clock Reference Frequencies:
(622.08MHz, 155.52MHz, 77.76MHz, 38.88MHz) or
(666.51MHz, 166.63MHz, 83.31MHz, 41.66MHz)
- ◆ LVDS Parallel Clock and Data Inputs
- ◆ CML Serial Data and Clock Outputs
- ◆ Additional CML Output for System Loopback Testing

Ordering Information

| PART | TEMP RANGE | PIN-PACKAGE | PKG CODE |
|-------------|----------------|-------------|----------|
| MAX3892EGH | -40°C to +85°C | 44 QFN | G4477-3 |
| MAX3892ETH+ | -40°C to +85°C | 44 TQFN | T4477-3 |

+Denotes a lead-free package.

Typical Application Circuit

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ABSOLUTE MAXIMUM RATINGS

Supply Voltage V_{CC}, V_{CCO}, V_{CCVCO}-0.5V to +5V
 All Inputs and FIL-0.5V to (V_{CC} + 0.5V)
 LVDS Output Voltage (PCLKO \pm)-0.5V to (V_{CC} + 0.5V)
 CML Output Current (SDO \pm , SCLKO \pm , SLBO \pm)22mA
 Continuous Power Dissipation (T_A = +85°C)
 44-Pin QFN (derate 25mW/°C above +85°C)1625mW

Operating Temperature Range-40°C to +85°C
 Storage Temperature Range-55°C to +150°C
 Lead Temperature (soldering, 10s)+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

(V_{CC} = +3.0V to +3.6V, T_A = -40°C to +85°C. Typical values are at V_{CC} = +3.3V, differential LVDS load = 100Ω ±1%, T_A = +25°C, unless otherwise noted.) (Note 1)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|--|--------------------|-----------------------------------|------------------------|------------------------|-----|-------------------|
| Supply Current | I _{CC} | (Note 2) | | 138 | 190 | mA |
| LVDS INPUT SPECIFICATIONS (PDI[3.0]\pm, PCLKI\pm) | | | | | | |
| Input Voltage Range | V _I | | 0 | 2400 | | mV |
| Differential Input Voltage | IV _{IDL} | | 100 | | | mV |
| Input Common-Mode Current | | LVDS input V _{OS} = 1.2V | 61 | | | μA |
| Threshold Hysteresis | | | 45 | | | mV |
| Differential Input Resistance | R _{IN} | | 83 | 100 | 117 | Ω |
| LVPECL INPUT SPECIFICATIONS (RCLK\pm) | | | | | | |
| Input High Voltage | V _{IH} | | V _{CC} - 1.16 | V _{CC} - 0.88 | | V |
| Input Low Voltage | V _{IL} | | V _{CC} - 1.81 | V _{CC} - 1.48 | | V |
| Input Bias Voltage | | | V _{CC} - 1.3 | | | V |
| Single-Ended Input Resistance | | | >1.0 | | | kΩ |
| Differential Input Voltage Swing | | | 300 | 1900 | | mV _{P-P} |
| LVDS OUTPUT SPECIFICATIONS (PCLKO\pm) | | | | | | |
| Output High Voltage | V _{OH} | | | 1.475 | | V |
| Output Low Voltage | V _{OL} | | 0.925 | | | V |
| Differential Output Voltage | IV _{OOL} | | 250 | 400 | | mV |
| Change in Magnitude of Differential Output Voltage for Complementary States | ΔIV _{OOL} | | | 25 | | mV |
| Offset Output Voltage | | | 1.125 | 1.275 | | V |
| Change in Magnitude of Output Offset Voltage for Complementary States | ΔV _{OOL} | | | 25 | | mV |

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DC ELECTRICAL CHARACTERISTICS (continued)

($V_{CC} = +3.0V$ to $+3.6V$, $T_A = -40^\circ C$ to $+85^\circ C$. Typical values are at $V_{CC} = +3.3V$, differential LVDS load = $100\Omega \pm 1\%$, $T_A = +25^\circ C$, unless otherwise noted.) (Note 1)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|----------|--------------------------------|----------------|-----|----------|-------------------|
| Differential Output Resistance | | | 80 | | 140 | Ω |
| Output Current | | Shorted together | | | 12 | mA |
| Output Current | | Shorted to ground | | | 40 | mA |
| CML OUTPUT SPECIFICATIONS (SDO \pm , SCLKO \pm , SLBO \pm) | | | | | | |
| Differential Output | | $R_L = 100\Omega$ differential | 640 | 800 | 1000 | mV _{P-P} |
| Differential Output Resistance | | | 83 | 100 | 117 | Ω |
| Output Common-Mode Voltage | | $R_L = 50\Omega$ to V_{CC} | $V_{CC} - 0.2$ | | V | |
| LVTTL SPECIFICATIONS (RESET, RATESET, SLBEN, SLBPD FIFOERROR, LOL) | | | | | | |
| Input High Voltage | V_{IH} | | 2.0 | | | V |
| Input Low Voltage | V_{IL} | | | | 0.8 | V |
| Input High Current | I_{IH} | | -30 | | +10 | μA |
| Input Low Current | I_{IL} | | -50 | | +10 | μA |
| Output High Voltage | V_{OH} | $I_{OH} = 20\mu A$ | 2.4 | | V_{CC} | V |
| Output Low Voltage | V_{OL} | $I_{OL} = 1mA$ | | | 0.4 | V |
| PROGRAMMING INPUTS (CLKSET, MODE) | | | | | | |
| Input Current | | Input = 0 or V_{CC} | -500 | | +500 | μA |

AC ELECTRICAL CHARACTERISTICS

($V_{CC} = +3.0V$ to $+3.6V$, $T_A = -40^\circ C$ to $+85^\circ C$. Typical values are at $V_{CC} = +3.3V$, differential LVDS loads = $100\Omega \pm 1\%$, CML loads = $50\Omega \pm 1\%$, $T_A = +25^\circ C$, unless otherwise noted.) (Note 3)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|-------------|------------------------------------|-------|-----|-----|-------|
| PARALLEL INPUT SPECIFICATIONS (PDI \pm , PCLKI \pm) | | | | | | |
| Parallel Input Data Rate | | RATESET = GND | 622 | | | Mbps |
| | | RATESET = V_{CC} | 666 | | | |
| Parallel Input Clock Rate | | MODE = OPEN or V_{CC} | 622 | | | MHz |
| | | MODE = SHORT or $30k\Omega$ to GND | 311 | | | |
| Parallel Input Setup Time | t_{SU} | (Note 4) | -94 | | | ps |
| Parallel Input Hold Time | t_H | (Note 4) | 300 | | | ps |
| PARALLEL CLOCK OUTPUT SPECIFICATIONS (PCLKO \pm) | | | | | | |
| Parallel Clock Output Rise/Fall Time | t_r, t_f | 20% to 80% | 100 | | 200 | ps |
| Parallel Clock Output Duty Cycle | | | 46 | | 54 | % |
| SERIAL OUTPUT SPECIFICATIONS (SDO \pm , SCLKO \pm) | | | | | | |
| Serial Output Data Rate | | RATESET = GND | 2.488 | | | Gbps |
| | | RATESET = V_{CC} | 2.666 | | | |
| Serial Data Output Rise/Fall Time | t_r, t_f | 20% to 80% | | | 80 | ps |
| Serial Output Clock to Data Delay | t_{CLK-Q} | (Note 5) | -25 | | 25 | ps |

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AC ELECTRICAL CHARACTERISTICS (continued)

($V_{CC} = +3.0V$ to $+3.6V$, $T_A = -40^\circ C$ to $+85^\circ C$. Typical values are at $V_{CC} = +3.3V$, differential LVDS loads = $100\Omega \pm 1\%$, CML loads = $50\Omega \pm 1\%$, $T_A = +25^\circ C$, unless otherwise noted.) (Note 3)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|--------|--------------------|-----|------|-----|-------|
| Serial Clock Output Jitter Generation | JG | (Notes 6 and 7) | | 1.0 | 1.4 | psRMS |
| Serial Data Output Random Jitter | RJ | (Note 7) | | | 1.4 | psRMS |
| Serial Data Output Deterministic Jitter | DJ | (Note 8) | | | 19 | psP-P |
| REFERENCE CLOCK INPUT SPECIFICATIONS (RCLK) | | | | | | |
| Reference Clock Frequency Tolerance | | | | ±100 | | ppm |
| Reference Clock Input Duty Cycle | | | 30 | 70 | | % |
| RESET INPUTS (RESET) | | | | | | |
| Minimum Pulse Width of FIFO Reset | | UI is PCLK0 period | | 4 | | UI |
| Tolerated Drift Between PCLKI and PCLKO After Reset | | UI is PCLK0 period | | ±1 | | UI |

Note 1: Specifications at $-40^\circ C$ are guaranteed by design and characterization.

Note 2: Measured with SLBO/CLK622 and SCLK outputs disabled and CML outputs open.

Note 3: AC characteristics are guaranteed by design and characterization.

Note 4: In 622MHz clock mode, the parallel data is clocked in by the rising edge of the 622MHz/666MHz parallel clock input. In the 311MHz clock mode, the parallel data is clocked in on both the rising and falling edges of the clock. The parallel input setup and hold time increases by 60ps if the duty cycle is between 48% to 52% in 311MHz mode (Figure 1).

Note 5: Relative to the falling edge of the SCLK0.

Note 6: Measurement bandwidth is $BW = 12\text{kHz}$ to 20MHz .

Note 7: Measured with 00001111 pattern, RCLK to PCLKI/PDI[3:0] phase approximately 40ps. See the *Jitter Generation vs. RCLK to PCLK/PDI[3:0] Phase* plot in the *Typical Operating Characteristics* section.

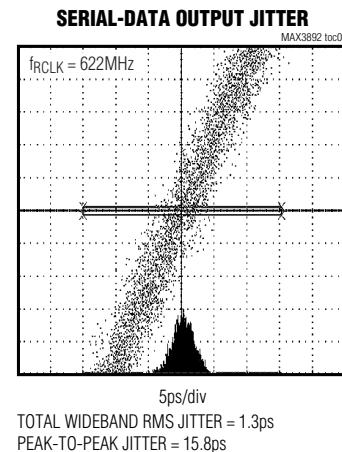
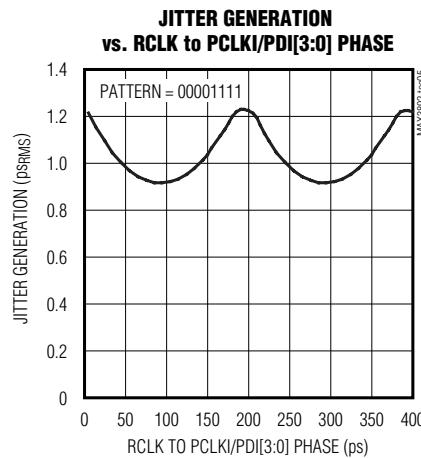
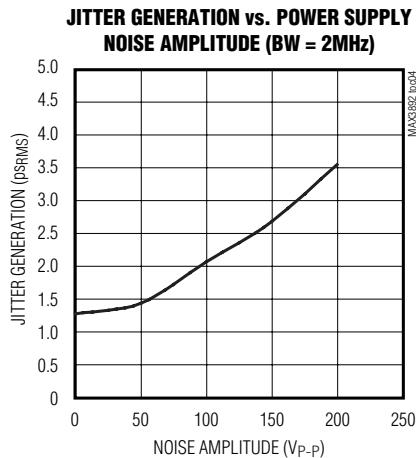
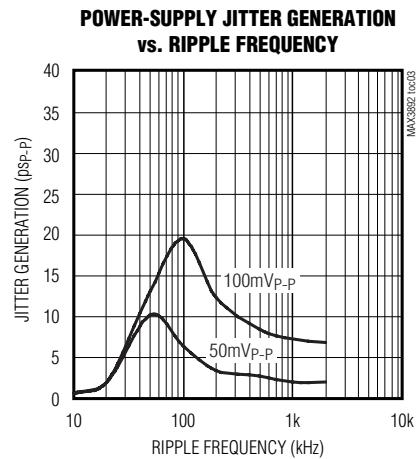
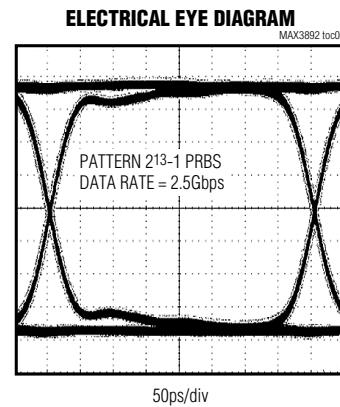
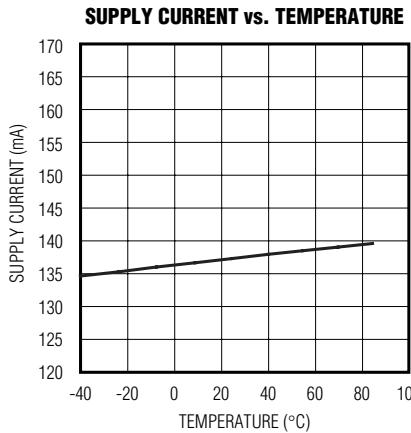
Note 8: Deterministic jitter includes pattern-dependent jitter and pulse-width distortion. Measured using a $2^7 - 1$ PRBS pattern with 96 consecutive identical digits.

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Typical Operating Characteristics

($V_{CC} = +3.3V$, CML loads AC-coupled to $50\Omega \pm 1\%$, $T_A = +25^\circ C$, unless otherwise noted.)

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Pin Description

| PIN | NAME | FUNCTION |
|-----------------------|--------|---|
| 1, 16, 22, 27, 33, 44 | GND | Supply Ground |
| 2, 5, 8, 11 | VCCO | Supply Voltage for Outputs +3.3V. Add bypass capacitors near these pins before connecting to the VCC power plane. |
| 3 | SCLKO- | Negative Serial Clock Output, CML 2.488GHz or 2.666GHz |
| 4 | SCLKO+ | Positive Serial Clock Output, CML 2.488GHz or 2.666GHz |
| 6 | SDO- | Negative Serial Data Output, CML 2.488Gbps or 2.666Gbps |
| 7 | SDO+ | Positive Serial Data Output, CML 2.488Gbps or 2.666Gbps |

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Pin Description (continued)

| PIN | NAME | FUNCTION |
|----------------|----------------|---|
| 9 | SLBO- | Negative System Loop-Back Output or 622MHz/666MHz Clock Output. Select CML data or clock as shown in Table 1. |
| 10 | SLBO+ | Positive System Loop-Back Output or 622MHz/666MHz Clock Output. Select CML data or clock as shown in Table 1. |
| 12 | SLBPD | System Loopback Power Down, TTL Input. SLPD = high activates the system loopback output driver; SLBPD = low powers down the loop-back output driver. |
| 13 | SLBEN | System Loop-Back Enable Input, TTL Input. SLBEN = high activates the system loop-back output; SLBEN = low activates the 622MHz/666MHz reference clock output. |
| 14 | RESET | FIFO Reset, TTL Input. An active-high reset recenters the FIFO to tolerate maximum skew between PCLKI and PCLKO. |
| 15 | FIFOERROR | FIFO Error Indicator, TTL Output. Active high when the read/write clocks access the same FIFO address. This signal may be used to control RESET. |
| 17, 28, 36, 43 | VCC | Supply Voltage, +3.3V |
| 18 | LOL | Loss of Lock, TTL Output. An active low indicates that the VCO and reference frequency differ by 500ppm. |
| 19 | MODE | Clock Control Input: MODE = GND; fPCLKI = 311.04MHz/333MHz with SCLKO active MODE = 30kΩ to GND; fPCLKI = 311.04MHz/333MHz with SCLKO off MODE = OPEN (float); fPCLKI = 622.08MHz/666MHz with SCLKO off MODE = Vcc; fPCLKI = 622.08MHz/666MHz with SCLKO active |
| 20 | PCLKI+ | Positive Parallel Clock, LVDS Input. Data is written to the input register on the clock rising edge in 622Mbps mode and on both rising and falling edges in 311Mbps mode (Figure 1). |
| 21 | PCLKI- | Negative Parallel Clock, LVDS Input (Figure 1). |
| 23, 25, 29, 31 | PDI3+ to PDI0+ | Positive Data Inputs, LVDS (622Mbps or 666Mbps) |
| 24, 26, 30, 32 | PDI3- to PDI0- | Negative Data Inputs, LVDS (622Mbps or 666Mbps) |
| 34 | PCLKO+ | Positive Parallel Clock Output, LVDS. This clock may be 622.08MHz or 666MHz. |
| 35 | PCLKO- | Negative Parallel Clock Output, LVDS. This clock may be 622.08MHz or 666MHz. |
| 37 | RCLK+ | Positive Reference Clock Input, LVPECL |
| 38 | RCLK- | Negative Reference Clock Input, LVPECL |
| 39 | CLKSET | Reference Clock Rate Programming Pin: CLKSET = Vcc; RCLK = 622.08MHz/666MHz CLKSET = OPEN (float); RCLK = 155.52MHz/167MHz CLKSET = 30kΩ to GND; RCLK = 77.76MHz/83.3MHz CLKSET = GND; RCLK = 38.88MHz/41.6MHz |
| 40 | RATESET | Data Rate Select, TTL Input. RATESET = high for 2.666Gbps, RATESET = low for 2.488Gbps. |
| 41 | VCCVCO | Supply Voltage for VCO +3.3V. Add bypass capacitors near this pin before connecting to the VCC power plane. |
| 42 | FIL | PLL Capacitor Pin. Connect a 0.1μF capacitor from this pin to VCCVCO. |
| EP | Exposed Paddle | The exposed paddle must be soldered to ground for proper thermal and electrical operation. |

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Detailed Description

The MAX3892 converts 4-bit-wide, 622Mbps/667Mbps data to 2.5Gbps/2.7Gbps serial data (Figure 2). Data is loaded into the 4:1 MUX through a 4×4 -bit FIFO buffer for wide tolerance to clock skew. Clock and data inputs are LVDS levels while high-speed serial outputs are CML. An internal PLL frequency synthesizer generates a serial clock from a low-speed reference clock.

Low-Voltage Differential-Signal Inputs and Outputs

The MAX3892 has LVDS inputs and outputs for interfacing with high-speed digital circuitry. The LVDS standard is based on the IEEE 1596.3 LVDS specification. This technology uses differential low-voltage swings to achieve fast transition times, minimized power dissipation, and noise immunity. For proper operation, the parallel clock LVDS outputs (PCLKO+, PCLKO-) require 100Ω differential DC termination between the positive and negative outputs. Do not terminate these outputs to ground. The parallel data and parallel clock LVDS inputs (PDI+, PDI-, PCLKI+, PCLKI-) are internally terminated with 100Ω differential input resistance, and therefore do not require external termination.

PECL Inputs

The reference clock (RCLK+, RCLK-) has PECL inputs for interfacing to a crystal oscillator with AC or DC connections. The RCLK inputs are self-biasing to $V_{CC} - 1.3V$ for AC-coupled inputs. Only a 100Ω differential termination resistance must be added when inputs are AC-coupled.

Current-Mode Logic Outputs

The 2.5Gbps/2.7Gbps data, clock, and system loop-back outputs (SDO+, SDO-, SCLKO+, SCLKO-, SLBO+, SLBO-) of the MAX3892 are designed using current-mode logic (CML). The configuration of the MAX3892 CML output circuit includes internal 50Ω back termination to V_{CC} (Figure 3). These outputs are intended to drive a 50Ω transmission line terminated with a matched load impedance.

FIFO Buffer

Data is latched into the MAX3892 by the parallel input clock PCLKI. The parallel input clock serves as the FIFO write clock. The parallel output clock PCLKO acts as the FIFO read clock that loads the 4:1 MUX. The FIFO allows the read and write clocks to vary by up to $\pm 1\text{UI}$. Conditions that result in the read and write clock accessing the same FIFO address are indicated by

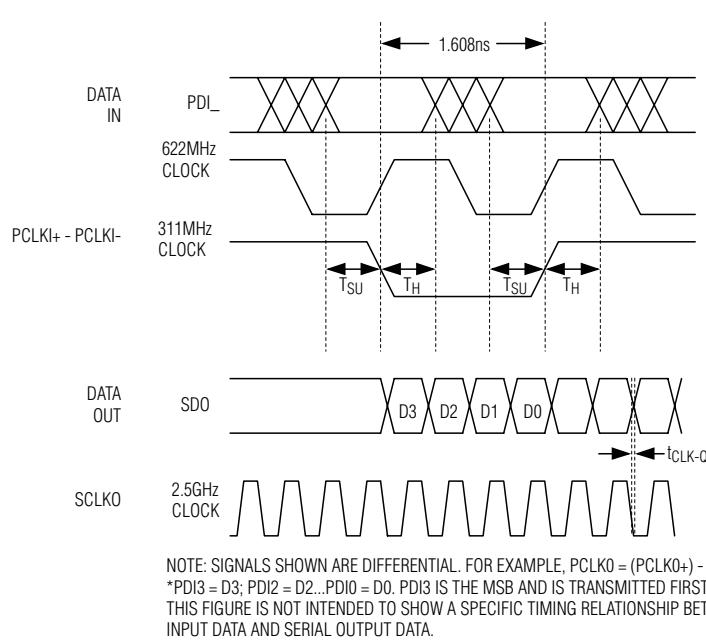


Figure 1. Timing Diagram

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Table 1. Loop-Back Operation Mode

| SLBPD | SLBEN | SLBO \pm OUTPUT |
|-----------------|-----------------|---|
| V _{IL} | X | Power-Down SLBO Output |
| V _{IH} | V _{IL} | 622MHz/667MHz Clock Output |
| V _{IH} | V _{IH} | 2.5Gbps/2.7Gbps System Loop-Back Output |

Table 2. Setting the Reference Clock Frequency

| CLKSET | RATESET | RCLK \pm FREQUENCY (MHz) |
|---------------------|-----------------|----------------------------|
| V _{CC} | V _{CC} | 666 |
| | GND | 622 |
| OPEN | V _{CC} | 166.5 |
| | GND | 155.52 |
| 30k Ω to GND | V _{CC} | 83.25 |
| | GND | 77.76 |
| GND | V _{CC} | 41.63 |
| | GND | 38.88 |

latching high FIFOERROR. To clear this condition, RESET must be asserted high for at least 4UI. FIFOERROR may be tied directly to the RESET input to recenter the FIFO. After reset, the full elastic range of the FIFO is available again.

Frequency Synthesizer

The PLL synthesizes a 2.5Gbps/2.7Gbps clock (SCLKO) from an external reference clock. The PLL reference clock (RCLK) may be 622.08MHz/666.53MHz, 155.52MHz/166.6MHz, 77.76MHz/83.3MHz or 38.88MHz/41.65MHz as determined by CLKSET and RATESET. See Table 2 for the reference frequency selection. The parallel output clock PCLKO is also derived from the synthesizer to be SCLKO divided by 4. A TTL-compatible loss-of-lock indicator, LOL, goes low when the VCO is unable to lock to the reference frequency. Frequency difference on RCLK with respect to the divided down SCLKO greater than 500ppm is indicated by a low state on LOL. When the frequency difference between the clocks is less than 250ppm, LOL high indicates a lock condition.

System Loopback

The MAX3892 is designed to allow system loop-back testing. The loop-back outputs (SLBO+, SLBO-) of the MAX3892 may be directly connected to the loop-back inputs of a deserializer (such as the MAX3882) for system diagnostics. Alternatively, the SLBO pins can be programmed to provide a 622MHz reference clock.

Table 3. Setting the Clock Mode

| MODE | RATESET | PCLKI \pm FREQUENCY (MHz) | SCLKO \pm FREQUENCY (GHz) |
|---------------------|-----------------|-----------------------------|-----------------------------|
| V _{CC} | V _{CC} | 666Hz | 2.666 |
| | GND | 622Hz | 2.488 |
| OPEN | V _{CC} | 666Hz | Disabled |
| | GND | 622Hz | Disabled |
| 30k Ω to GND | V _{CC} | 333Hz | Disabled |
| | GND | 311Hz | Disabled |
| GND | V _{CC} | 333Hz | 2.666 |
| | GND | 311Hz | 2.488 |

This reference clock can provide a clock hold-over signal to a clock and data recovery (CDR) circuit in the event of loss of signal (LOS).

Design Procedure

Clock Mode Selection

The frequencies of the MAX3892 can be set up using CLKSET, RATESET, and MODE as shown in Tables 2 and 3.

Layout Techniques

For best performance, use good high-frequency layout techniques. Filter voltage supplies and keep ground connections short. Use multiple vias where possible. Also, use controlled-impedance transmission lines to interface with the MAX3892 clock and data inputs and outputs.

Exposed-Pad Package

The EP 44-pin QFN incorporates features that provide a very low thermal-resistance path for heat removal from the IC to a PC board. The MAX3892's EP must be soldered directly to a ground plane with good thermal conductance.

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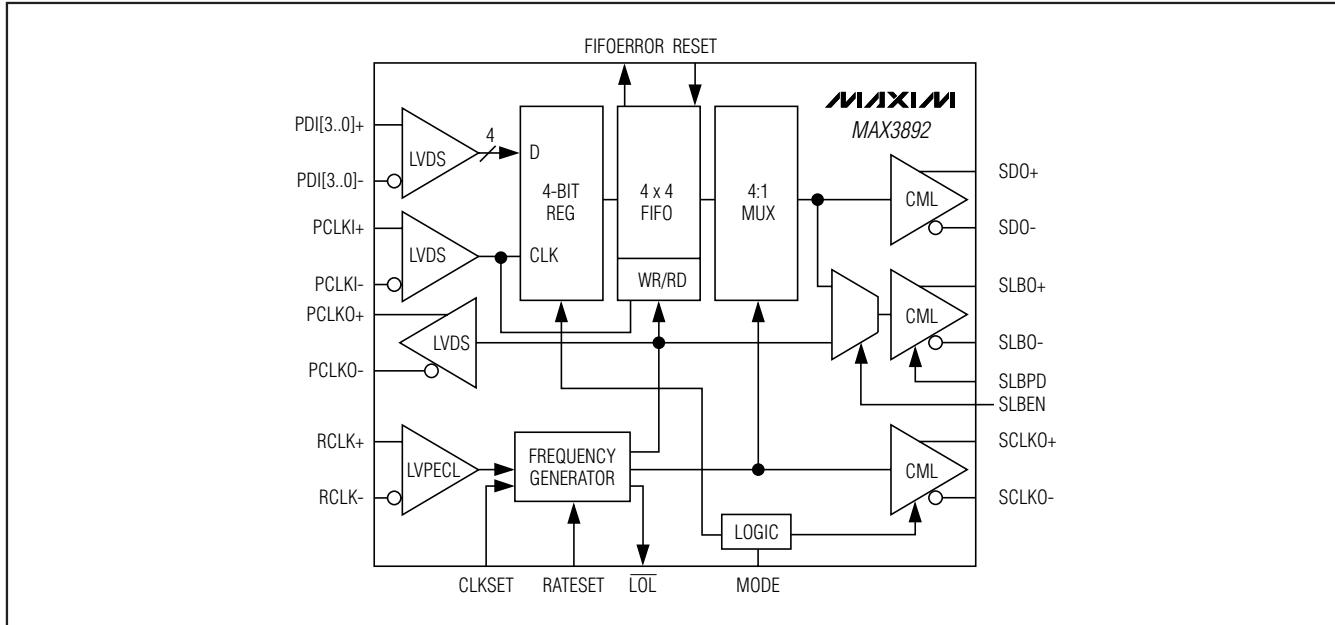


Figure 2. Functional Diagram

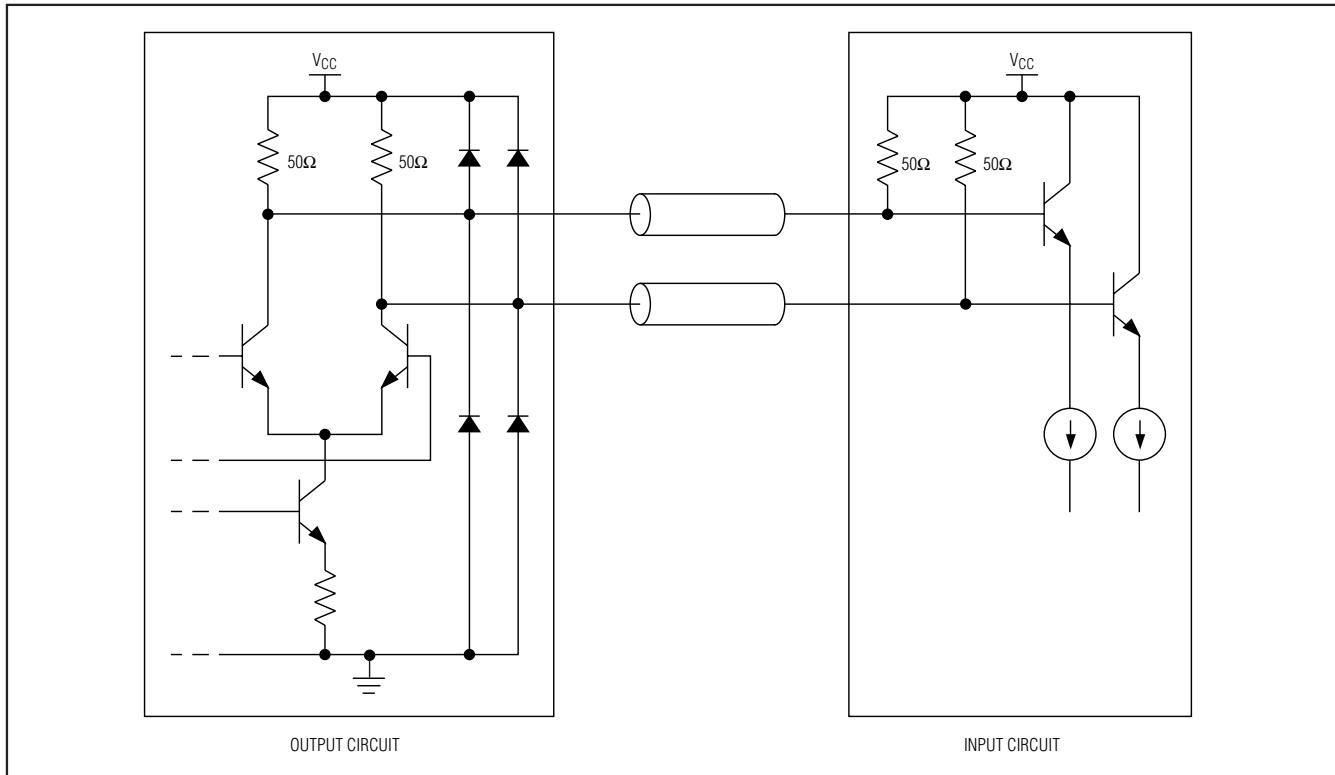


Figure 3. Current-Mode Logic

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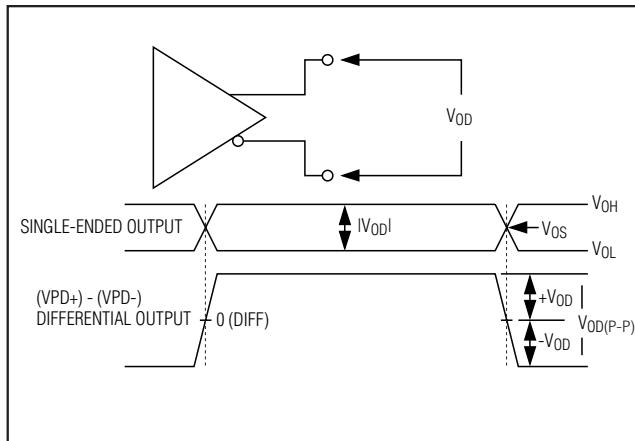
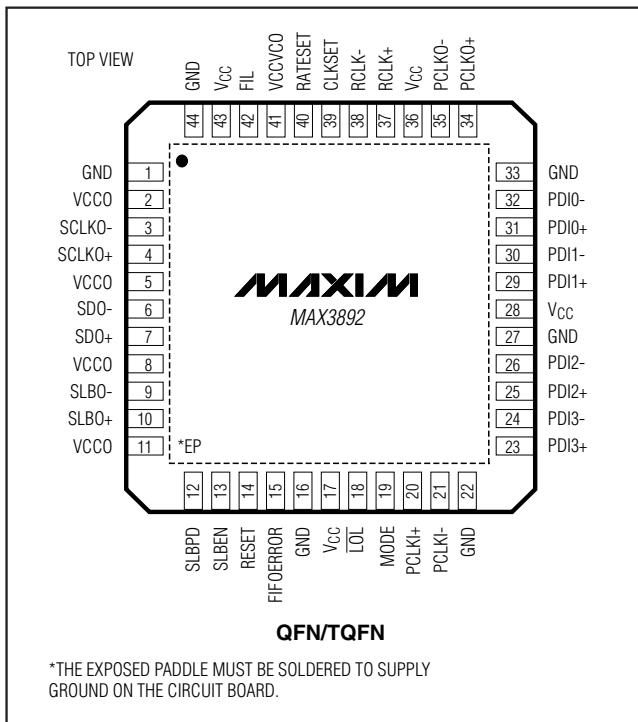


Figure 4. Differential Output Levels

Pin Configuration



Chip Information

TRANSISTOR COUNT: 6210

Package Information

(For the latest package outline information, go to www.maxim-ic.com/packages.)

| PACKAGE TYPE | DOCUMENT NO. |
|--------------|----------------|
| 44 QFN | 21-0092 |
| 44 TQFN | 21-0144 |

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Revision History

Rev 0; 11/01: Original data sheet release.

Rev 1; 5/03: Page 1: added package code; page 11: updated package drawing.

Rev 2; 3/06: Page 1: updated Typical Application Circuit; page 6: corrected pin numbers for VCC and VCCVCO; page 10: corrected pin names.

Rev 3; 6/06: Page 4: updated AC table for JG conditions/typ, PJ conditions, DJ conditions, and added new Note 7; page 5: added new TOC5.

Rev 4; 12/06: Page 1: removed future status from MAX3882 in Typical Application Circuit; page 5: updated TOC3.

Rev 5; 2/07: Page 1: added lead-free package to Ordering Information table.

Rev 6; 10/07: Page 1: clarified that the MAX3892EHT+ is a TQFN package; page 10: added TQFN to the Pin Configuration; pages 11–12: removed package drawings and replaced with package type table.

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